

L Number	Hits	Search Text	DB	Time stamp
4	169	(@ad<=20010111 and (438/637).ccls.) and 'Ti' with 'barrier'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/11 11:29
5	1	@ad<=20010111 and 'Ti' with 'barrier' same 'anneal' with 'hydrogen'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/11 11:31
6	4	@ad<=20010111 and 'Ti' same 'barrier' same 'anneal' with 'hydrogen'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/11 11:31
17	1035	@ad<=20010111 and (257/750-753).ccls. and 'barrier'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/11 11:47
-	16	@ad<=20010111 and 'dielectric' with 'titanium' and 'conductive barrier' and 'conductive plug'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 09:40
-	173	@ad<=20010111 and (438/600).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/11 11:43
-	49	@ad<=20010111 and (438/600).ccls. and 'titanium' and 'titanium nitride'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 08:47
-	47	@ad<=20010111 and (438/600).ccls. and 'titanium' and 'titanium nitride' and 'tungsten'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 08:48
-	3	@ad<=20010111 and 'dielectric' with 'titanium' with 'anneal' and 'hydrogen'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 10:22
-	94	@ad<=20010111 and 'pre metal dielectric layer'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 09:49
-	37	(@ad<=20010111 and 'pre metal dielectric layer') and 'titanium'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 09:50
-	10	@ad<=20010111 and 'refractory metal' adj 'hydrogen'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 10:06
-	0	@ad<=20010111 and 'dielectric' with 'titanium' with 'hydrogen treatment'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/05/20 10:16

